

LPC55S2x/LPC552x

Errata sheet LPC55S2x/LPC552x

Rev. 2.6 — 25 July 2024

Errata

Document information

Information	Content
Keywords	LPC55S28JBD100, LPC55S26JBD100, LPC55S28JEV98, LPC55S26JEV98, LPC55S28JBD64, LPC55S26JBD64, LPC5528JBD100, LPC5526JBD100, LPC5528JEV98, LPC5526JEV98, LPC55S28JEV59, LPC5528JBD64, LPC5526JBD64, LPC5528JEV59
Abstract	LPC55S2x/LPC552x errata



1 Product identification

The LPC55S2x/LPC552x VFBGA98 package has the following top-side marking:

- First line: LPC55S2x/LPC552x
- Second line: JEV98
- Third line: xxxxxxxx
- Fourth line: zzzzyywwxR
 - yyww: Date code with yy = year and ww = week.
 - xR: Device revision 1B

The LPC55S2x/LPC552x HLQFP100 package has the following top-side marking:

- First line: LPC55S2xJBD100/LPC552xJBD100
- Second line: xxxxxxxx
- Third line: zzzzyywwxR
 - yyww: Date code with yy = year and ww = week.
 - xR: Device revision 1B

The LPC55S2x/LPC552x HTQFP64 package has the following top-side marking:

- First line: LPC55S2x/LPC552x
- Second line: JBD64
- Third line: xxxx
- Fourth line: xxxx
- Fifth line: zzzzyywwxR
 - yyww: Date code with yy = year and ww = week.
 - xR: Device revision 1B

The LPC55S28 and LPC5528 VFBGA59 package has the following top-side marking:

- First line: S28/5528
- Second line: xxxx
- Third line: zzywwxR
 - yww: Date code with y = year and ww = week.
 - xR: Device revision 1B

2 Errata overview

Table 1. Functional problems table

Functional problems	Short description	Revision identifier	Detailed description
ADC.1	Async interrupts with resume not supported.	1B	Section 3.1
ROM.1	ROM fails to enter ISP mode when image is corrupted with flash pages in an erased or unprogrammed state.	1B	Section 3.2
USB.1	USB HS host fails when connecting to an LS device (mouse).	1B	Section 3.3
USB.2	Automatic USB rate adjustment not functional when using multiple hubs.	1B	Section 3.4
USB.3	For the USB high-speed device controller, the detection handshaking fails when certain full-speed hubs are connected.	1B	Section 3.5

Table 1. Functional problems table...continued

Functional problems	Short description	Revision identifier	Detailed description
WAKEIO.1	Wake-up I/O cause register identifies the wake-up I/O (WAKEUP pins) source from deep power-down mode.	1B	Section 3.6
USB.4	In USB high-speed device mode, device writes extra byte(s) to the buffer if the NBytes is not multiple of 8 for OUT transfer.	1B	Section 3.7
USB.5	In USB high-speed device mode, when device isochronous IN endpoint sends a packet of MaxPacket Size of 1024 bytes in response to IN token from host, the isochronous IN endpoint interrupt is not set and the endpoint command/status list entry for the isochronous IN endpoint is not updated.	1B	Section 3.8
USB.6	In USB high-speed host mode, only one transaction per micro-frame is allowed for isochronous IN endpoints.	1B	Section 3.9
DM-AP.1	I2C ISP via debug mailbox is not functional.	1B	Section 3.10
VBAT_DCDC.1	The minimum rise time of the power supply must be 2.6 ms or slower for Tamb = -40 C, and 0.5 ms or slower for Tamb = 0 C to +105 C.	1B	Section 3.11
ROM.2	ROM API can't be used correctly to update and read monotonic counter in CFPA.VENDOR_USAGE word.	0A, 1B	Section 3.12
ROM.3	ENTER_ISP_MODE mailbox command does not work.	1B	Section 3.13
PLL.1	PLL LOCK bit is not reliable	1B	Section 3.14

Table 2. AC/DC deviations table

AC/DC deviations	Short description	Product version(s)	Detailed description
n/a	n/a	n/a	n/a

Table 3. Errata notes

Errata notes	Short description	Revision identifier	Detailed description
ISP.1	Devices with date code 2101 (yyww) onward, contain ROM Bootloader version T1.1.5 or higher with run Bootloader API to enter into ISP mode.	1B	Section 5.1 ROM run Bootloader API to enter ISP mode does not work".
ROM.4	Stack pointer for application code cannot be located in the SRAM area when shared with PowerQuad RAM and USB RAM.	1B	Section 5.2 Stack pointer for application code cannot be located in the SRAM area when shared with PowerQuad RAM and USB RAM".
ROM.5	Devices with date code 2222 (yyww) and onwards contain ROM Target version T1.1.0 (or higher). On these devices, the get-property command is not	1B	Section 5.3 ROM get-property is not functional".

Table 3. Errata notes...continued

Errata notes	Short description	Revision identifier	Detailed description
	functional and as a result, bootloader properties like target version cannot be read.		
ROM.10	Devices with date code between 2219 (yyww) and 2227 (yyww) contain ROM Target version T1.1.8. On these devices, accessing reserved region (RAM3) in ISP mode results in hard fault and does not return kStatusMemoryRangeInvalid error code to the host.	1B	Section 5.4 On devices with total SRAM size of 256 KB, accessing reserved region RAM3 will result in hard fault"
ROM.11	Devices with date code between 2219 (yyww) and 2227 (yyww) contain ROM Target version T1.1.8. On these devices, accessing reserved region (RAM3 and RAM4) in ISP mode results in hard fault and does not return kStatusMemoryRangeInvalid error code to the host.	1B	Section 5.5 On devices with total SRAM size of 144 KB, accessing reserved regions RAM3 and RAM4 will result in hard fault"

3 Functional problems detail

3.1 ADC.1: Async interrupts with resume not supported

Introduction

The ADC controller is available on all LPC55S2x/LPC552x devices. Trigger detect with up to 16 trigger sources is supported with priority level configuration. A software or hardware trigger option is provided for each.

Problem

The following problems are all related to the restart after interrupt feature:

- Low priority trigger executes twice when resumed.
- Trigger can't restart when it is configured to do so.
- Incorrect trigger resumed after exception.

Work-around

There is no work-around.

The async interrupts with resume is not supported on device revisions 0A and 1B.

3.2 ROM.1: ROM fails to enter ISP mode when image is corrupted with flash pages in an erased or unprogrammed state

Introduction

On the LPC55S2x/LPC552x, if the image is corrupted with flash pages in an erased or unprogrammed state, the ROM may fail to automatically enter ISP mode.

Problem

When secure boot is enabled in CMPA, and the flash memory contains an erased or unprogrammed memory page inside the memory region specified by the image size field in the image header, the device does not automatically enter into ISP mode using the fallback mechanism, as in the case of a failed boot for an invalid

image. This problem occurs when the application image is only partially written or erased but a valid image header is still present in memory.

Work-around

Perform a mass-erase to remove the incomplete and corrupted image using one of the following methods:

- Execute the erase command using Debug Mailbox. The device will enter directly into ISP mode after exiting the mailbox.
- Enter into ISP mode using the Debug Mailbox command and use the flash-erase command.
- Reset the device and enter into ISP mode using the ISP pin. Use the flash-erase command to erase the corrupted (incomplete) image.

3.3 USB.1: HS host fails when connecting with the LS device (mouse)

Introduction

The USB1 high-speed controller is available on select LPC55S2x/LPC552x devices and provides a plug-and-play connection of peripheral devices to a host with three different data speeds:

- high-speed with a data rate of 480Mbps.
- full-speed with a data rate of 12 Mbps.
- low-speed with a data rate of 1.5 Mbps.

Many portable devices can benefit from the ability to communicate with each other over the USB interface without intervention of a host PC.

Problem

USB HS host fails when connecting with an LS device (mouse).

Work-around

To support Full-Speed and Low-Speed applications, it is recommended to use the USB0 Full-Speed port and the USB1 High-speed port for Device or Host. In addition, should an application require support of Low-Speed USB devices with a USB High-Speed Host, this can be accomplished by inserting a USB Hub between the USB1 High-speed port and external USB devices.

3.4 USB.2: Automatic USB rate adjustment is not functional when using multiple hubs

Introduction:

Full-speed and low-speed signaling uses bit stuffing throughout the packet without exception. If the receiver sees seven consecutive ones anywhere in the packet, then a bit stuffing error has occurred, and the packet should be ignored.

The time interval just before an End of Packet (EOP) is a special case. The last data bit before the EOP can become stretched by hub switching skews. This is known as dribble and can lead to a situation where dribble introduces a sixth bit that does not require a bit stuff. Therefore, the receiver must accept a packet where there are up to six full bit times at the port with no transitions prior to the EOP.

Problem:

The LPC55S2x/LPC552x devices use the start of an EOP for frequency measurements. This is not functional when going through multiple hubs that introduce a dribble bit because of hub switching skews. For this reason, the start of the EOP cannot be used for frequency measurements for automatic USB rate adjustment (by setting USBCLKADJ in the FRO192M_CTRL register). The problem does not occur when a single hub is used.

Work-around:

Use the FRO calibration library provided in technical note TN00063. This library allows the application to have a crystal-less USB device operation in full-speed mode.

3.5 USB.3: For the USB high-speed device controller, the detection handshaking fails when certain full-speed hubs are connected**Introduction**

See the USB2.0 specification for details regarding the USB High-speed Detection Handshake protocol.

Problem

As a high-speed device, when certain full-speed hubs are connected, the USB device does not detect the HOST KJ sequence correctly and, as a result, does not recognize the speed of the connected host. In this case, the USB device can act erratically due to the wrong speed detection.

Work-around

There are two workarounds:

1. The software work-around below can be implemented in `usb_dev_hid_mouse` where API is called "`USB_DeviceHsPhyChirpIssueWorkaround()`". In event handler in `USB_DeviceCallback()`,
 - On "`kUSB_DeviceEventBusReset`" event, `USB_DeviceHsPhyChirpIssueWorkaround()` should be called to identify the speed of the host connected to. If full-speed host is connected or "`isConnectedToFsHostFlag`" is set, `FORCE_FS` (bit 21) of `DEVCMDSTAT` register should be set to force the device operating in full-speed mode.
 - On "`kUSB_DeviceEventDetach`" event, `FORCE_FS` (bit 21) of `DEVCMDSTAT` register should be cleared.
2. The software workaround below is available in tech note (TN00071) In event handler in `USB_DeviceCallback()`,
 - On "`kUSB_DeviceEventAttach`" event, set `PHY_RX` register trip-level voltage to the highest. `USBPHY->RX &= ~(USBPHY_RX_ENVADJ_MASK); USBPHY->RX |= 2;`
 - On "`kUSB_DeviceEventBusReset`" event, check the `DEVCMDSTAT[SPEED]` to determine the connected bus speed. (`SPEED` are bits 22 and 23). If `DEVCMDSTAT[SPEED]=FS`, `FORCE_FS` (bit 21) of `DEVCMDSTAT` should be set to force the device operating in full-speed mode.
 - On "`kUSB_DeviceEventGetDeviceDescriptor`" event, or first `SETUP` packet has arrived, Set the `USBPHY_RX[ENVADJ]` field back to default 0. Otherwise, `USBPHY_RX[ENVADJ]` field will remain as 2 unless a disconnect event occurs.
 - On "`kUSB_DeviceEventDetach`" event, Clear `FORCE_FS` (bit 21) of `DEVCMDSTAT` register to zero. Reset `USBPHY_RX[ENVADJ]` field back to default 0.

3.6 WAKEIO.1: Wake-up I/O register reports incorrect wake-up source

Introduction

On the LPC55S2x/LPC552x, a wake-up I/O cause register is available to identify the wake-up I/O (WAKEUP pins) source from deep power-down mode.

Problem

Before entering DEEP-POWER-DOWN, the following configuration is set for the wake-up sources:

- Wake-up I/O 0 as falling edge.
- Wake up I/O 1 as rising edge.
- Wake up I/O 2 is disabled.
- Wake up I/O 3 as falling edge.

1st case: The first wake up event is a rising edge on wake up I/O 1. PMC->WAKEIOCAUSE will indicate Wake-up I/O 0 trigger (wrong), Wake up I/O 1 trigger (correct) and Wake up I/O 3 trigger (wrong) as wake up I/O cause.

2nd case: The first wake up event is a falling edge on wake up I/O 3. PMC->WAKEIOCAUSE will indicate Wake-up I/O 0 trigger (wrong) and Wake up I/O 3 trigger (correct) as wake up I/O cause.

3rd case: The first wake up event is an RTC. PMC->WAKEIOCAUSE will indicate Wake-up I/O 0 trigger (wrong) and Wake up I/O 3 trigger (wrong) as wake up I/O cause.

Work-around

None. This issue does not occur when the wake I/O is not configured as falling edge.

3.7 USB.4: In USB high-speed device mode, device writes extra byte(s) to the buffer

Introduction

The LPC55S2x/LPC552x device family include a USB high-speed interface (USB1) that can operate in device mode at high-speed. The NBytes value represents the number of bytes that can be received in the buffer.

Problem

The LPC55S2x/LPC552x USB device controller writes extra bytes to the receive data buffer if the size of the transfer is not a multiple of 8 bytes since the USB device controller always writes 8 bytes. For example, if the transfer length is 1 bytes, 7 extra bytes will be written to the receive data buffer. If the transfer length is 7 bytes, 1 extra bytes will be written to the receive data buffer.

Work-around

Reserve an additional, intermediary buffer along with the buffer used by the application for USB data. After the USB data transfer into the intermediary buffer has been completed, use memcpy to move the data from the intermediary buffer into the application buffer, skipping the extraneous extra byte. This software work-around is implemented on the SDK software platform.

3.8 USB.5: In USB high-speed device mode, when device isochronous IN endpoint sends a packet of MaxPacketSize of 1024 bytes in response to IN token from host, the

isochronous IN endpoint interrupt is not set and the endpoint command/status list entry for the isochronous IN endpoint is not updated

Introduction

The LPC55S2x/LPC552x device family include a USB high-speed interface (USB1) that can operate in device mode at high-speed. The isochronous IN endpoint supports a MaxPacketSize of 1024 bytes.

Problem

When device isochronous IN endpoint sends a packet of MaxPacketSize of 1024 bytes in response to IN token from host, the isochronous IN endpoint interrupt is not set and the endpoint command/status list entry for the isochronous IN endpoint is not updated.

Work-around

Restrict the isochronous IN endpoint MaxPacketSize to 1023 bytes in device descriptor.

3.9 USB.6: In USB high-speed host mode, only one transaction per micro-frame is allowed for isochronous IN endpoints

Introduction

The LPC55S2x/LPC552x device family include a USB high-speed interface which can operate in host mode. Up to three high-speed transactions are allowed in a single micro-frame to support high-bandwidth endpoints. This mode is enabled by setting the Mult (Multiple) field in the Proprietary Transfer Descriptor (PTD) and is used to indicate to the host controller the number of transactions that should be executed per micro-frame. The allowed bit settings are:

- 00b Reserved. A zero in this field yields undefined results.
- 01b One transaction to be issued for this endpoint per micro-frame.
- 10b Two transactions to be issued for this endpoint per micro-frame.
- 11b Three transactions to be issued for this endpoint per micro-frame.

Problem

For High-bandwidth mode, using multiple packets (MULT = 10b or 11b) in a frame causes unreliable operation. Only one transaction (MULT = 01b) can be issued per micro-frame.

Work-around

There is no software workaround. Only one transaction can be issued per micro-frame.

3.10 DM-AP.1: I2C ISP via debug mailbox is not functional

Introduction

The LPC55S2x/LPC552x supports I2C ISP mode via debug mailbox. By default, ISP mode entry is determined by the state of the ISP boot selection pins at reset time. Usually this functionality is disabled through PFR configuration prior to field deployment or when ISP boot selection pins are used for some other board function.

In this situation, the DM_AP command "Enter ISP mode" can be used to enter one of the ISP modes (UART, SPI, I2C, USB-HID). Parameter value of 0x2 can be used to enter I2C ISP mode.

Problem

I2C ISP via debug mailbox cannot be entered and is not functional.

Work-around

There is no software workaround.

3.11 VBAT_DCDC.1: The minimum rise time of the power supply must be 2.6 ms or slower for Tamb = -40 C, and 0.5 ms or slower for Tamb = 0 C to +105 C

Introduction

The datasheet specifies no power-up requirements for the power supply on the VBAT_DCDC pin.

Problem

The device might not always start-up if the minimum rise time of the power supply ramp is 2.6 ms or faster for Tamb = -40 C, and 0.5 ms or faster for Tamb = 0 C to +105 C.

Work-around

None.

3.12 ROM.2: ROM API can't be used correctly to update and read monotonic counter in CFPA.VENDOR_USAGE word

Introduction

Customer Field Programmable Area (CFPA) of Protected Flash Region (PFR) contains VENDOR_USAGE word. The lower 16-bits of the VENDOR_USAGE word implement a monotonic counter which should contain current value or higher value when new version of CFPA page is written. Upper 16-bits of the VENDOR_USAGE word should contain inverse value of aforesaid monotonic counter.

Problem

In the ROM, 16-bit monotonic counter is implemented by upper 16-bits of the VENDOR_USAGE word while lower 16-bits contain inverse value of monotonic counter i.e Monotonic Counter and its inverse value are swapped erroneously in the ROM. Due this error, ROM APIs do not access VENDOR_USAGE monotonic counter correctly.

Work-around

User should increment and store Monotonic Counter value in upper 16-bits of VENDOR_USAGE word while inverse value of the monotonic counter should be stored in the lower 16-bits of the VENDOR_USAGE word.

3.13 ROM.3: ENTER_ISP_MODE mailbox command does not work

Introduction

The Debug Mailbox is used to communicate with code executing in the ROM by sending mailbox commands. ENTER_ISP_MODE mailbox command is used to put device in the ISP mode.

Problem

ENTER_ISP_MODE mailbox command does not work in the devices with boot ROM version T1.1.3 or lower.

Work-around

There is no work around. This issue is fixed in the ROM Bootloader versions T1.1.4 or higher, i.e. date code 1935 (yyww) onward.

3.14 PLL.1: PLL LOCK bit is not reliable

Introduction

On the LPC55S2x/LPC552x devices, PLLxSTAT register of PLLs contains a LOCK detector status bit (bit 0 of PLLxSTAT register).

When the LOCK detector status bit is set to 1, the PLL is considered to be locked and stable.

The PLL LOCK signal is specified to work for Fref range from 100 kHz to 20 MHz. When the Fref is below 100 kHz or above 20 MHz, software should use a 6 ms time interval to insure the PLL will be stable.

Problem

On the LPC55S2x/LPC552x, the PLL status LOCK bit is not always reliable in the ranges specified and as a result, the PLL doesn't initialize correctly.

Work-around

For $F_{ref} \geq 20$ MHz:

Software must wait at least $(500\mu s + 400/F_{ref})$ (F_{ref} in Hz result in s) to ensure the PLL is stable.

For $F_{ref} < 20$ MHz:

- If the PLL lock detector status bit is 1 before the wait time duration $((500\mu s + 400/F_{ref}))$ is completed, the PLL is stable.
- If the PLL lock detector status bit is 0 but the wait time duration $((500\mu s + 400/F_{ref}))$ is completed, the PLL is stable.

Software workaround is implemented in SDK 2.14 clock driver version 2.3.7.

Remark: This errata does not apply for spread spectrum mode.

4 AC/DC deviations detail

No known errata.

5 Errata notes detail

5.1 ISP.1: ROM runBootloader API to enter ISP mode does not work

Introduction

Devices with date code 2101 (yyww) onward, contain ROM Bootloader version T1.1.5 or higher with runBootloader API to enter into ISP mode.

Problem

RunBootloader API does not work as described in the User Manual.

Work-around

User should use below code in their application to invoke auto ISP mode instead of runBootloader API.

```
PMC->AOREG1 |= (0X0A <<16);  
NVIC_SystemReset();
```

5.2 ROM.4: Stack pointer for application code cannot be located in the SRAM area when shared with PowerQuad RAM and USB RAM

Introduction

Stack pointer for application code cannot be located in the SRAM area when shared with PowerQuad RAM and USB RAM.

Problem

ROM fails to check image if image stack address is $\geq 0x20040000$ and will enter ISP mode.

Work-around

Workaround is to modify the Startup.s and assign the stack pointer to an address $< 0x20040000$. SDK examples have been modified to handle this scenario.

5.3 ROM.5: ROM get-property is not functional

Introduction

ROM provides get-property command feature to provide bootloader properties.

Problem

Devices with date code 2222 (yyww) and onwards contain ROM Target version T1.1.0 (or higher). On these devices, the get-property command is not functional and as a result, bootloader properties like target version cannot be read. On devices with date code before 2222 (yyww), get-property command is functional.

Work-around

None.

5.4 ROM.10: On devices with total SRAM size of 256 KB, accessing reserved region RAM3 will result in hard fault

Introduction

In ISP mode, boot ROM returns kStatusMemoryRangInvalid error code to the host when accessing reserved region.

Problem

Devices with date code between 2219 (yyww) and 2227 (yyww) contain ROM Target version T1.1.8. On these devices, accessing reserved region (RAM3) in ISP mode results in hard fault and does not return kStatusMemoryRangInvalid error code to the host.

Devices with date code between 2228 (yyww) and onwards contains ROM Target version T1.1.0. On these devices, accessing reserved region (RAM3) in ISP mode returns kStatusMemoryRangInvalid error code to the host.

Work-around

None.

5.5 ROM.11: On devices with total SRAM size of 144 KB, accessing reserved regions RAM3 and RAM4 will result in hard fault

Introduction

In ISP mode, boot ROM returns kStatusMemoryRangInvalid error code to the host when accessing reserved region.

Problem

Devices with date code between 2219 (yyww) and 2227 (yyww) contain ROM Target version T1.1.8. On these devices, accessing reserved regions (RAM3 and RAM4) in ISP mode results in hard fault and does not return kStatusMemoryRangInvalid error code to the host.

Devices with date code between 2228 (yyww) and onwards contains ROM Target version T1.1.0. On these devices, accessing reserved regions (RAM3 and RAM4) in ISP mode returns kStatusMemoryRangInvalid error code to the host.

Work-around

None.

6 Revision history

Table 4. Revision history

Document ID	Release date	Description
ES_LPC55S2x/LPC552x v. 2.6	25 July 2024	<ul style="list-style-type: none">Added VFBGA59 package details in Section 1.Updated the 'First line' under HLQFP100 package marking in Section 1.
ES_LPC55S2x/LPC552x v. 2.5	19 Decemeber 2023	<ul style="list-style-type: none">Added Section 5.4, Section 5.5
ES_LPC55S2x/LPC552x v. 2.4	16 June 2023	<ul style="list-style-type: none">Added Section 3.14
ES_LPC55S2x/LPC552x v. 2.3	18 Janauary 2023	<ul style="list-style-type: none">Updated Table 3.Added Section 5.3In Section 5.2 updated title from "ROM.1: Stack pointer for application code cannot be located in the SRAM area when shared with PowerQuad RAM and USB RAM" to "ROM.4: Stack pointer for application code cannot be located in the SRAM area when shared with PowerQuad RAM and USB RAM".
ES_LPC55S2x/LPC552x v. 2.2	20 June 2022	<ul style="list-style-type: none">Added Section 3.13Added Section 3.12
ES_LPC55S2x/LPC552x v. 2.1	38 February 2022	Updated Section 5.1 and short description of ISP.1 in Table 3 .
ES_LPC55S2x/LPC552x v. 2.0	10 November 2021	Added Section 5.2 in Section 5 "Errata notes detail"
ES_LPC55S2x/LPC552x v. 1.9	10 August 2021	Added VBAT_DCDC.1: Section 3.11
ES_LPC55S2x/LPC552x v. 1.8	23 April 2021	<ul style="list-style-type: none">Added USB.5 errata, Section 3.8Added USB.6 errata, Section 3.9Added DM-AP.1 errata, Section 3.10
ES_LPC55S2x/LPC552x v. 1.7	25 February 2021	Added USB.4 errata, Section 3.7
ES_LPC55S2x/LPC552x v. 1.6	14 December 2020	Includes Section 3.5
ES_LPC55S2x/LPC552x v. 1.5	3 November 2020	Adds Section 3.6
ES_LPC55S2x/LPC552x v. 1.4	27 August 2020	Adds Section 5.1
ES_LPC55S2x/LPC552x v. 1.3	4 December 2019	Updated workaround in Section 3.2
ES_LPC55S2x/LPC552x v. 1.2	21 October 2019	Enhances product identification and adds USB.1 and USB.2 errata.
ES_LPC55S2x/LPC552x v. 1.1	23 September 2019	Describes ROM failure to enter ISP mode when an image is corrupted with flash pages in an erased or unprogrammed state.
ES_LPC55S2x/LPC552x v. 1.0	19 July 2019	Initial version.

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